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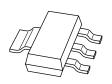
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Kind regards,

Team Nexperia



 500 V, 1 A NPN high-voltage low V_{CEsat} (BISS) transistor

 Rev. 01 — 11 December 2009
 Product data

Product data sheet

Product profile 1.

1.1 General description

NPN high-voltage low V_{CEsat} Breakthrough In Small Signal (BISS) transistor in a medium power SOT223 (SC-73) Surface-Mounted Device (SMD) plastic package.

PNP complement: PBHV9540Z.

1.2 Features

- High voltage
- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability I_C and I_{CM}
- High collector current gain (h_{FE}) at high I_C
- AEC-Q101 qualified
- Medium power SMD plastic package

1.3 Applications

- LED driver for LED chain module
- LCD backlighting
- Automotive motor management
- Switch Mode Power Supply (SMPS)

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CESM}	collector-emitter peak voltage	$V_{BE} = 0 V$	-	-	500	V
V _{CEO}	collector-emitter voltage	open base	-	-	400	V
I _C	collector current		-	-	1	А
h _{FE}	DC current gain	V _{CE} = 10 V; I _C = 50 mA	[1] 100	155	-	

[1] Pulse test: $t_p \le 300 \ \mu s$; $\delta \le 0.02$.



500 V, 1 A NPN high-voltage low V_{CEsat} (BISS) transistor

2. Pinning information

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	base		
2	collector		2, 4
3	emitter		1
4	collector		`` ``
			3
			sym016

3. Ordering information

Table 3. Orde	ering informat	ion	
Type number	Package		
	Name	Description	Version
PBHV8140Z	SC-73	plastic surface-mounted package with increased heatsink; 4 leads	SOT223

4. Marking

Table 4.	Marking codes	
Type num	ber	Marking code
PBHV814)Z	V8140Z

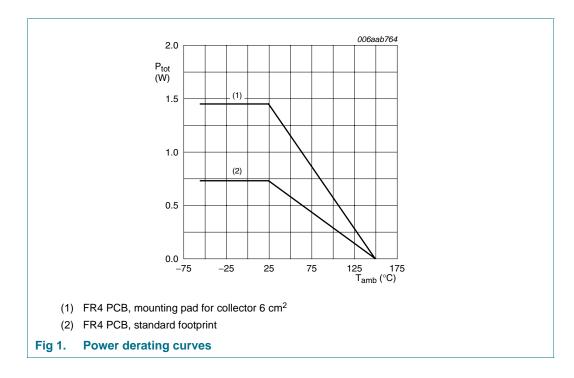
500 V, 1 A NPN high-voltage low V_{CEsat} (BISS) transistor

5. Limiting values

Table 5. In accordar	Limiting values ace with the Absolute Maximu	ım Rating System (IE	C 60134).		
Symbol	Parameter	Conditions	Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter	-	500	V
V _{CEO}	collector-emitter voltage	open base	-	400	V
V _{CESM}	collector-emitter peak voltage	$V_{BE} = 0 V$	-	500	V
V _{EBO}	emitter-base voltage	open collector	-	6	V
I _C	collector current		-	1	А
I _{CM}	peak collector current	single pulse; $t_p \leq 1 \text{ ms}$	-	2	A
I _{BM}	peak base current	single pulse; $t_p \leq 1 \text{ ms}$	-	400	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> -	0.73	W
			[2] _	1.45	W
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T _{stg}	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for collector 6 cm².



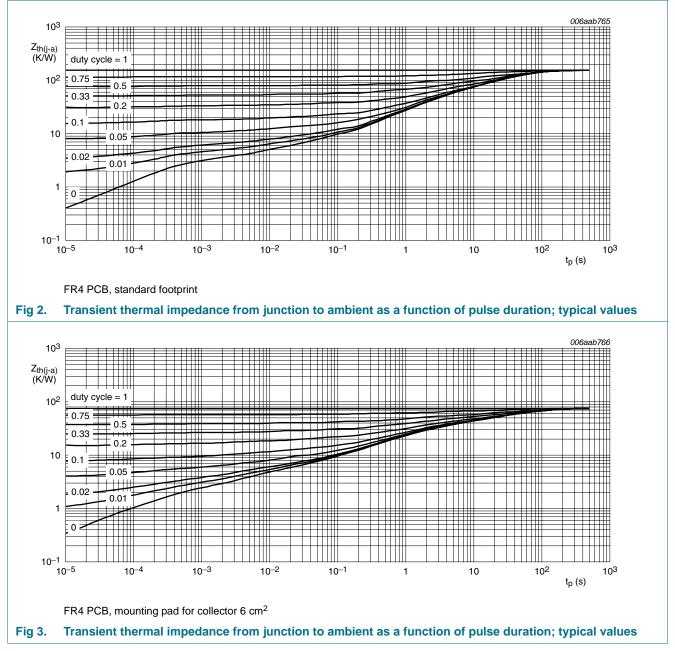
500 V, 1 A NPN high-voltage low V_{CEsat} (BISS) transistor

6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from	in free air	<u>[1]</u> -	-	170	K/W
junction to a	junction to ambient		[2] _	-	85	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point		-	-	15	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for collector 6 cm².



500 V, 1 A NPN high-voltage low V_{CEsat} (BISS) transistor

7. Characteristics

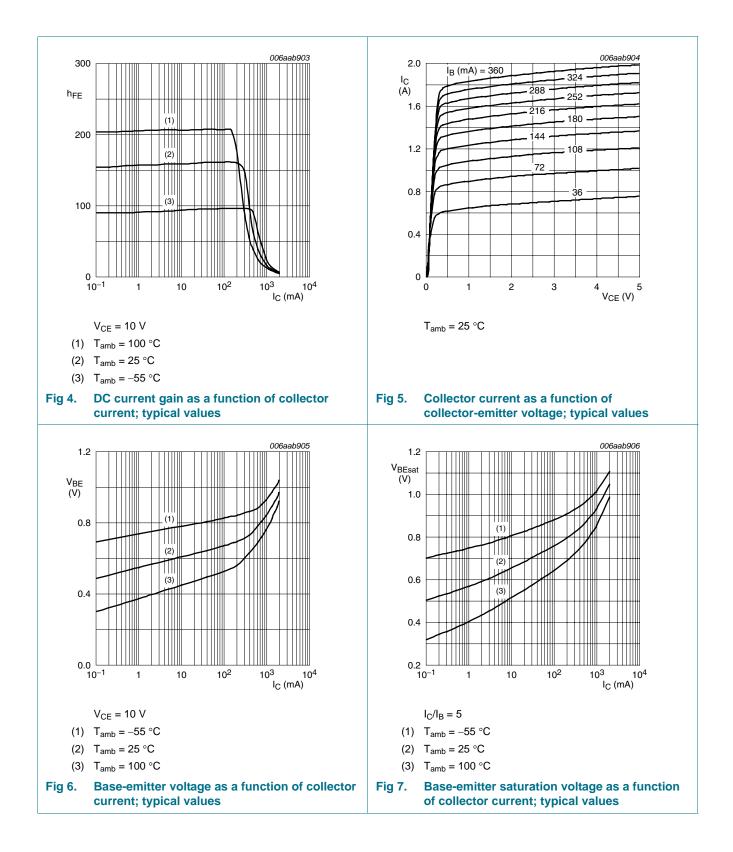
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
I _{CBO}	collector-base cut-off	$V_{CB} = 320 \text{ V}; \text{ I}_{E} = 0 \text{ A}$		-	-	100	nA
	current	$V_{CB} = 320 \text{ V}; I_E = 0 \text{ A};$ $T_j = 150 \text{ °C}$		-	-	10	μA
I _{CES}	collector-emitter cut-off current	$V_{CE} = 320 \text{ V}; \text{ V}_{BE} = 0 \text{ V}$		-	-	100	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 4 \text{ V}; \text{ I}_{C} = 0 \text{ A}$		-	-	100	nA
h _{FE}	DC current gain	V _{CE} = 10 V					
		I _C = 50 mA		100	155	-	
		I _C = 100 mA	[1]	80	150	-	
		I _C = 500 mA	[1]	35	65	-	
		I _C = 1 A	[1]	10	20	-	
V _{CEsat}	collector-emitter	$I_{C} = 100 \text{ mA}; I_{B} = 10 \text{ mA}$	[1]	-	45	80	mV
	saturation voltage	$I_{C} = 100 \text{ mA}; I_{B} = 20 \text{ mA}$	[1]	-	30	50	mV
		$I_{C} = 500 \text{ mA}; I_{B} = 100 \text{ mA}$	[1]	-	85	140	mV
		I _C = 1 A; I _B = 200 mA	[1]	-	150	250	mV
R _{CEsat}	collector-emitter saturation resistance	I _C = 1 A; I _B = 200 mA	[1]	-	150	250	mΩ
V _{BEsat}	base-emitter saturation voltage	I _C = 1 A; I _B = 200 mA	<u>[1]</u>	-	0.95	1.1	V
t _d	delay time	$V_{CC} = 6 \text{ V}; \text{ I}_{C} = 0.5 \text{ A};$		-	25	-	ns
t _r	rise time	$I_{Bon} = 0.1 \text{ A}; I_{Boff} = -0.1 \text{ A}$		-	2820	-	ns
t _{on}	turn-on time			-	2845	-	ns
t _s	storage time			-	2585	-	ns
t _f	fall time			-	1215	-	ns
t _{off}	turn-off time			-	3800	-	ns
f _T	transition frequency	$V_{CE} = 10 \text{ V}; I_{C} = 10 \text{ mA};$ f = 100 MHz		-	25	-	MHz
C _c	collector capacitance	$V_{CB} = 20 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz		-	12	-	pF
C _e	emitter capacitance	$V_{EB} = 0.5 \text{ V}; I_C = i_c = 0 \text{ A};$ f = 1 MHz		-	600	-	pF

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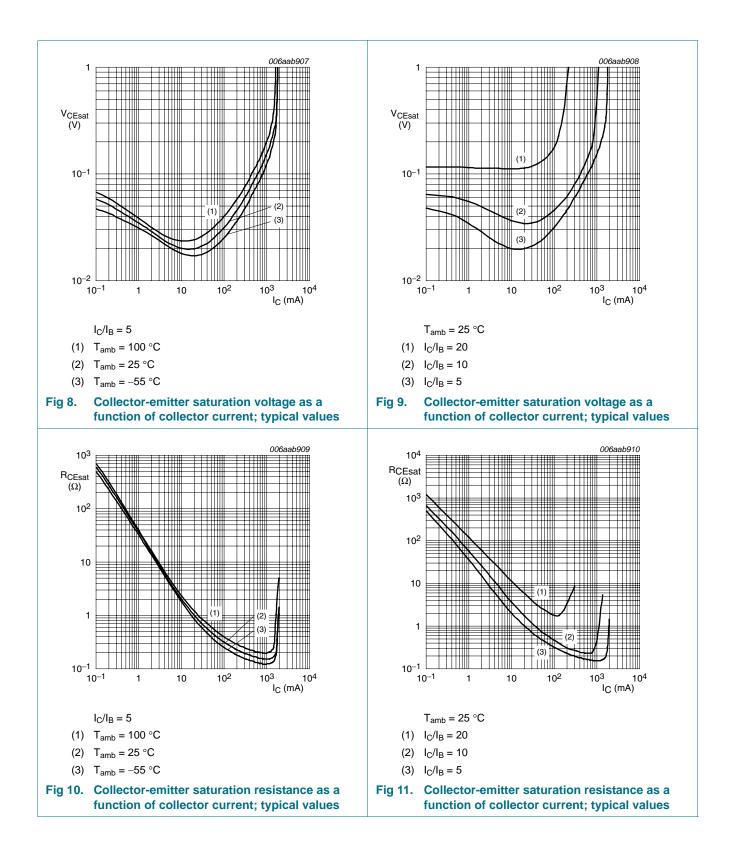




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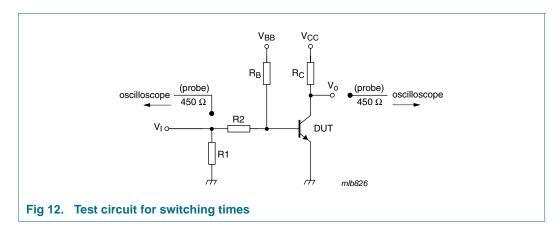
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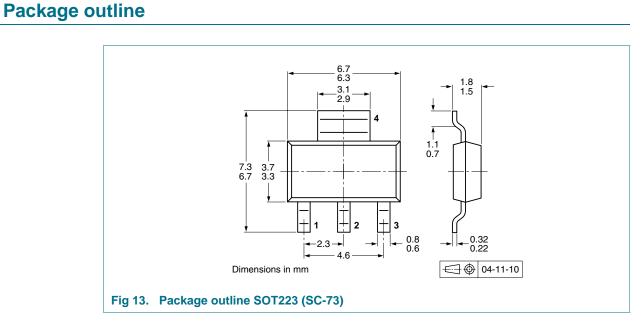
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8. Test information



8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.



10. Packing information

Table 8.Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.

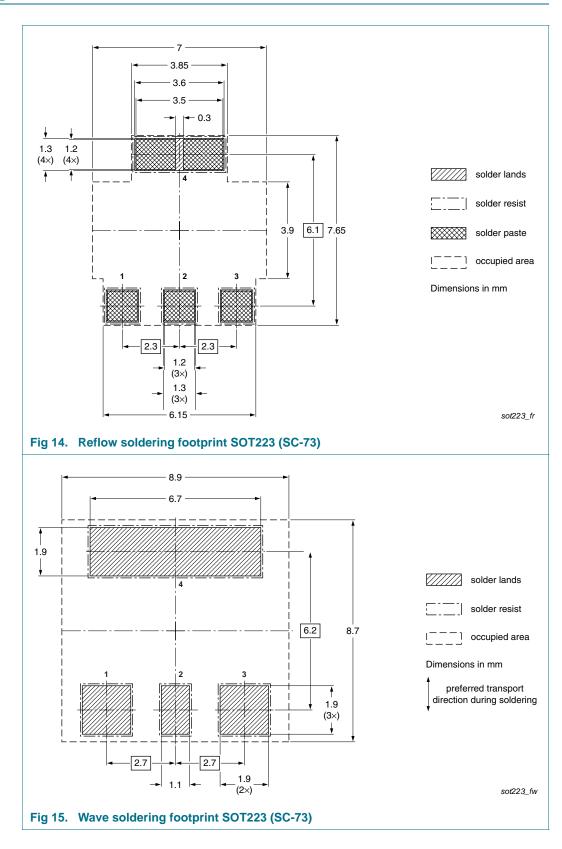
Type number	Package	Description	Packing quantity	
			1000	4000
PBHV8140Z	SOT223	8 mm pitch, 12 mm tape and reel	-115	-135

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

9.

500 V, 1 A NPN high-voltage low V_{CEsat} (BISS) transistor

11. Soldering



PBHV8140Z_1

Product data sheet

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500 V, 1 A NPN high-voltage low V_{CEsat} (BISS) transistor

12. Revision history

Table 9. Rev	ision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
PBHV8140Z_1	20091211	Product data sheet	-	-	

500 V, 1 A NPN high-voltage low V_{CEsat} (BISS) transistor

13. Legal information

Data sheet status 13.1

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

The term 'short data sheet' is explained in section "Definitions". [2]

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PBHV8140Z 1

NXP Semiconductors

PBHV8140Z

500 V, 1 A NPN high-voltage low V_{CEsat} (BISS) transistor

15. Contents

1	Product profile 1
1.1	General description 1
1.2	Features
1.3	Applications 1
1.4	Quick reference data 1
2	Pinning information 2
3	Ordering information 2
4	Marking 2
5	Limiting values 3
6	Thermal characteristics 4
7	Characteristics 5
8	Test information 8
8.1	Quality information 8
9	Package outline 8
10	Packing information 8
11	Soldering 9
12	Revision history 10
13	Legal information 11
13.1	Data sheet status 11
13.2	Definitions 11
13.3	Disclaimers
13.4	Trademarks 11
14	Contact information 11
15	Contents 12

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